# **PDTD123Y series**

NPN 500 mA, 50 V resistor-equipped transistors;R1 = 2.2 kΩ, R2 = 10 kΩRev. 02 — 16 November 2009Pro

**Product data sheet** 

# 1. Product profile

## 1.1 General description

500 mA NPN Resistor-Equipped Transistors (RET) family.

### Table 1. Product overview

Type number	Package		PNP complement	
	NXP	JEITA	JEDEC	
PDTD123YK	SOT346	SC-59A	TO-236	PDTB123YK
PDTD123YS <sup>[1]</sup>	SOT54	SC-43A	TO-92	PDTB123YS
PDTD123YT	SOT23	-	TO-236AB	PDTB123YT

[1] Also available in SOT54A and SOT54 variant packages (see Section 2).

## 1.2 Features

- Built-in bias resistors
- Simplifies circuit design
- 500 mA output current capability

## **1.3 Applications**

- Digital application in automotive and industrial segment
- Controlling IC inputs

## 1.4 Quick reference data

### Table 2. Quick reference data

Symbol Conditions Parameter Min Тур Max Unit V VCFO collector-emitter voltage open base --50 output current (DC) --500 mΑ  $I_0$ bias resistor 1 (input) R1 1.54 2.2 2.86 kΩ R2/R1 bias resistor ratio 4.1 4.55 5



- Reduces component count
- Reduces pick and place costs
- ±10 % resistor ratio tolerance
- Cost saving alternative for BC817 series in digital applications
- Switching loads

# 2. Pinning information

Pin	Description	Simplified outline	Symbol
SOT54			
1	input (base)		
2	output (collector)		
3	GND (emitter)		
SOT54A			
1	input (base)		
2	output (collector)		
3	GND (emitter)	1 2 001aab348	1 R1 R2 006aaa145
SOT54 va	ariant		
1	input (base)		
2	output (collector)		
3	GND (emitter)	() () () () () () () () () () () () () (	1 R1 R2 006aaa145
SOT23, S	OT346		
1	input (base)		
2	GND (emitter)	3	
3	output (collector)	12	1 R2 sym007

## 3. Ordering information

Table 4. Ordering information						
Type number	Package	age				
	Name	Description	Version			
PDTD123YK	SC-59A	plastic surface mounted package; 3 leads	SOT346			
PDTD123YS <sup>[1]</sup>	SC-43A	plastic single-ended leaded (through hole) package; 3 leads	SOT54			
PDTD123YT	-	plastic surface mounted package; 3 leads	SOT23			

[1] Also available in SOT54A and SOT54 variant packages (see Section 2 and Section 9).

## 4. Marking

### Table 5.Marking codes

Type number	Marking code <sup>[1]</sup>
PDTD123YK	E7
PDTD123YS	D123YS
PDTD123YT	*7X

- [1] \* = -: made in Hong Kong
  - \* = p: made in Hong Kong
  - \* = t: made in Malaysia
  - \* = W: made in China

# 5. Limiting values

#### Table 6.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Мах	Unit
				50	V
V <sub>CBO</sub>	collector-base voltage	open emitter	-		
V <sub>CEO</sub>	collector-emitter voltage	open base	-	50	V
V <sub>EBO</sub>	emitter-base voltage	open collector	-	5	V
VI	input voltage				
	positive		-	+12	V
	negative		-	-5	V
lo	output current (DC)		-	500	mA
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	[1]		
	SOT346		-	250	mW
	SOT54		-	500	mW
	SOT23		-	250	mW
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		-	150	°C
T <sub>amb</sub>	ambient temperature		-65	+150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

# 6. Thermal characteristics

Table 7.	Thermal characteristics	5				
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air	<u>[1]</u>			
	SOT346		-	-	500	K/W
	SOT54		-	-	250	K/W
	SOT23		-	-	500	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

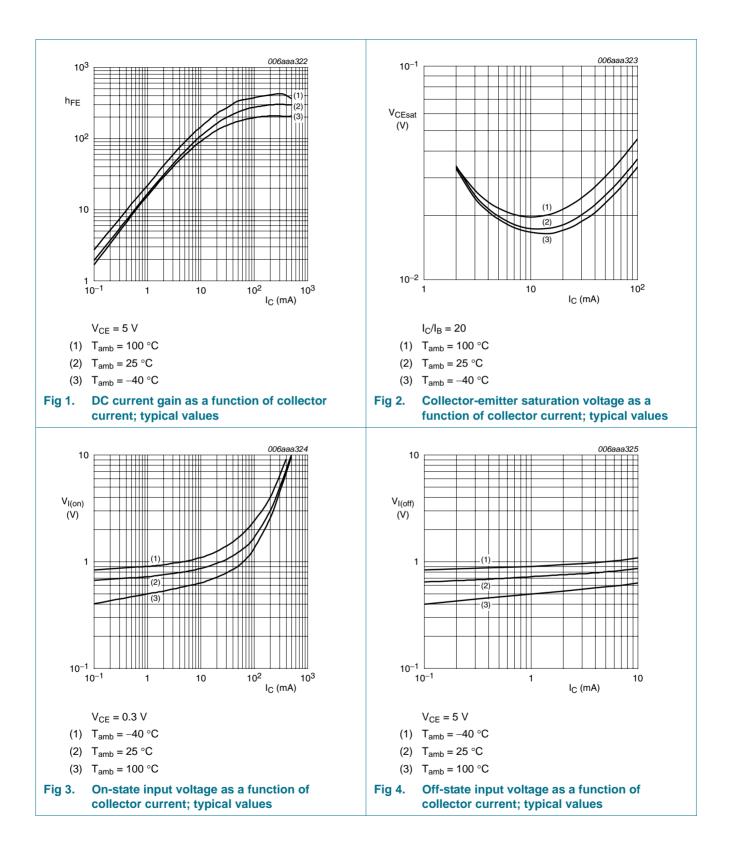
# 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I <sub>CBO</sub> c	collector-base cut-off	$V_{CB} = 40 \text{ V}; I_E = 0 \text{ A}$	-	-	100	nA
	current	$V_{CB} = 50 \text{ V}; I_E = 0 \text{ A}$	-	-	100	nA
I <sub>CEO</sub>	collector-emitter cut-off current	$V_{CE} = 50 \text{ V}; \text{ I}_{B} = 0 \text{ A}$	-	-	0.5	μA
I <sub>EBO</sub>	emitter-base cut-off current	$V_{EB} = 5 V; I_C = 0 A$	-	-	0.65	mA
h <sub>FE</sub>	DC current gain	$V_{CE} = 5 \text{ V}; I_{C} = 50 \text{ mA}$	70	-	-	
V <sub>CEsat</sub>	collector-emitter saturation voltage	$I_{\rm C}$ = 50 mA; $I_{\rm B}$ = 2.5 mA	-	-	0.3	V
V <sub>I(off)</sub>	off-state input voltage	$V_{CE}$ = 5 V; $I_C$ = 100 $\mu$ A	0.4	0.6	1	V
V <sub>I(on)</sub>	on-state input voltage	$V_{CE}$ = 0.3 V; $I_{C}$ = 20 mA	0.5	1	1.4	V
R1	bias resistor 1 (input)		1.54	2.2	2.86	kΩ
R2/R1	bias resistor ratio		4.1	4.55	5	
Cc	collector capacitance	$V_{CB}$ = 10 V; $I_E$ = $i_e$ = 0 A; f = 1 MHz	-	7	-	pF

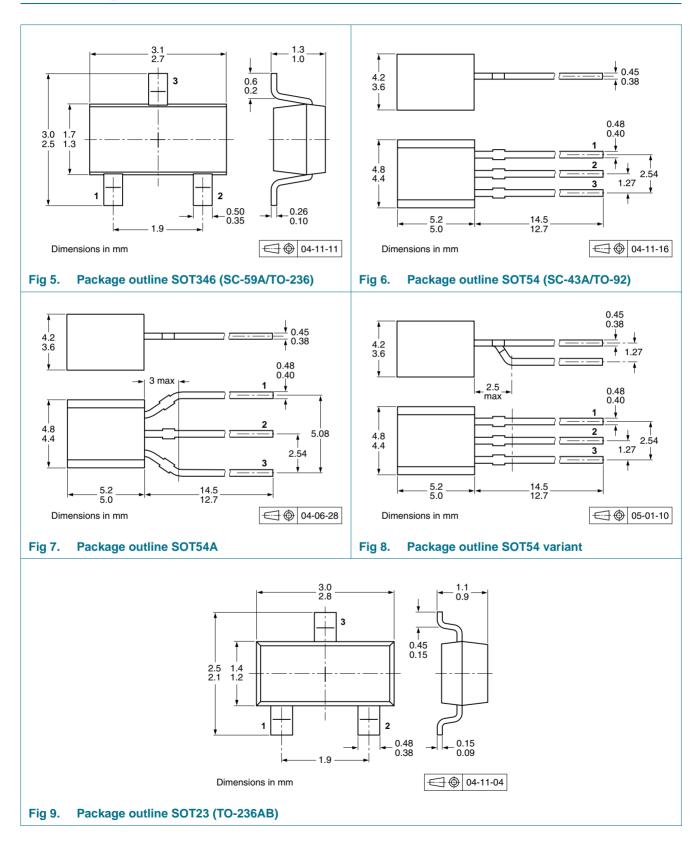
### Table 8.Characteristics

# **PDTD123Y series**

### NPN 500 mA resistor-equipped transistors; R1 = 2.2 k $\Omega$ , R2 = 10 k $\Omega$



## 8. Package outline



# 9. Packing information

Type number	Package	Description	Packin	g quanti	ty
			3000	5000	10000
PDTD123YK	SOT346	4 mm pitch, 8 mm tape and reel	-115	-	-135
PDTD123YS	SOT54	bulk, straight leads	-	-412	-
	SOT54A	tape and reel, wide pitch	-	-	-116
		tape ammopack, wide pitch	-	-	-126
	SOT54 variant	bulk, delta pinning	-	-112	-
PDTD123YT	SOT23	4 mm pitch, 8 mm tape and reel	-215	-	-235

[1] For further information and the availability of packing methods, see <u>Section 12</u>.

# **10. Revision history**

Table 10. Revision hi	story			
Document ID	Release date	Data sheet status	Change notice	Supersedes
PDTD123Y_SER_2	20091116	Product data sheet	-	PDTD123Y_SER_1
Modifications:		eet was changed to reflect w legal definitions and disc		
PDTD123Y_SER_1	20050412	Product data sheet	-	-

# **11. Legal information**

## **11.1** Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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[2] The term 'short data sheet' is explained in section "Definitions".

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